

GC50MPS06-247

650V 50A SiC Schottky MPS™ Diode



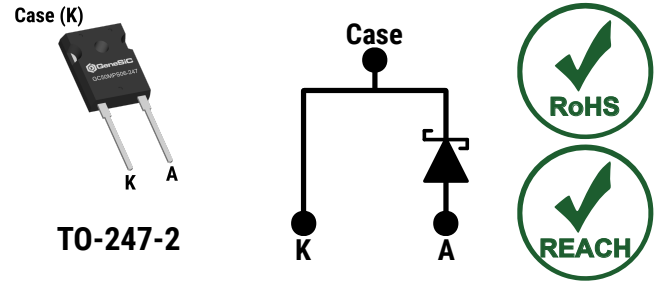
Silicon Carbide Schottky Diode

V_{RRM}	=	650 V
$I_F (T_C = 135^\circ\text{C})$	=	59 A
Q_C	=	140 nC

Features

- Low V_F for High Temperature Operation
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit Q_C/I_F
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness

Package



Advantages

- Improved System Efficiency
- High System Reliability
- Optimal Price Performance
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

Applications

- Power Factor Correction (PFC)
- Electric Vehicles and Battery Chargers
- Solar Inverters
- High Frequency Converters
- Switched Mode Power Supply (SMPS)
- Motor Drives
- Anti-Parallel / Free-Wheeling Diode
- Induction Heating & Welding

Absolute Maximum Ratings (At $T_C = 25^\circ\text{C}$ Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V_{RRM}		650	V	
Continuous Forward Current	I_F	$T_C = 100^\circ\text{C}, D = 1$	86	A	Fig. 4
		$T_C = 135^\circ\text{C}, D = 1$	59		
		$T_C = 145^\circ\text{C}, D = 1$	50		
Non-Repetitive Peak Forward Surge Current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	400	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	320		
Repetitive Peak Forward Surge Current, Half Sine Wave	$I_{F,RM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	240	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	168		
Non-Repetitive Peak Forward Surge Current	$I_{F,MAX}$	$T_C = 25^\circ\text{C}, t_P = 10 \mu\text{s}$	2000	A	
i^2t Value	$\int i^2 dt$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	800	A^2s	
Non-Repetitive Avalanche Energy	E_{AS}	$L = 0.7 \text{ mH}, I_{AS} = 50 \text{ A}$	841	mJ	
Diode Ruggedness	dV/dt	$V_R = 0 \sim 520 \text{ V}$	200	V/ns	
Power Dissipation	P_{TOT}	$T_C = 25^\circ\text{C}$	454	W	Fig. 3
Operating and Storage Temperature	T_j, T_{stg}		-55 to 175	$^\circ\text{C}$	

Electrical Characteristics

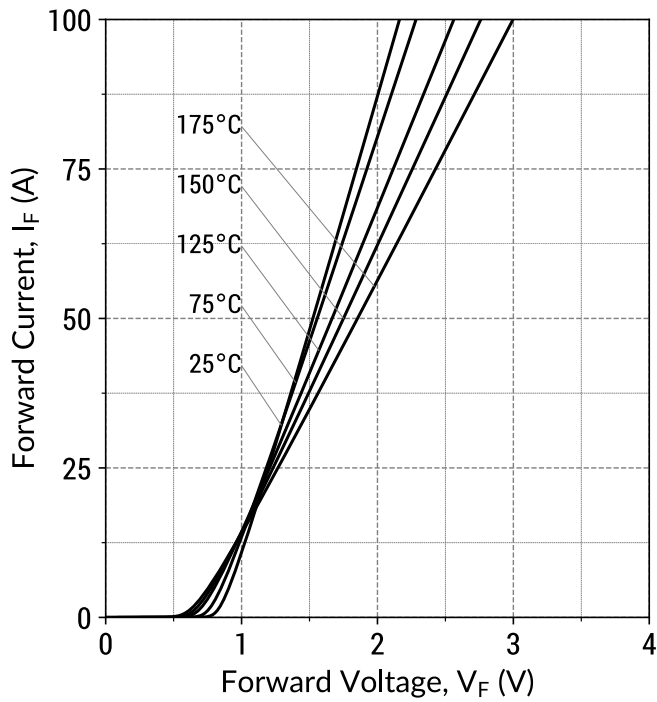
Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Diode Forward Voltage	V_F	$I_F = 50 \text{ A}, T_j = 25^\circ\text{C}$		1.5	1.8	V	Fig. 1
		$I_F = 50 \text{ A}, T_j = 175^\circ\text{C}$		1.8			
Reverse Current	I_R	$V_R = 650 \text{ V}, T_j = 25^\circ\text{C}$		1	5	μA	Fig. 2
		$V_R = 650 \text{ V}, T_j = 175^\circ\text{C}$		16			
Total Capacitive Charge	Q_C	$I_F \leq I_{F,MAX}$ $di_F/dt = 200 \text{ A}/\mu\text{s}$	$V_R = 200 \text{ V}$	96		nC	Fig. 7
			$V_R = 400 \text{ V}$	140			
Switching Time	t_s	$di_F/dt = 200 \text{ A}/\mu\text{s}$	$V_R = 200 \text{ V}$	< 10		ns	
			$V_R = 400 \text{ V}$				
Total Capacitance	C	$V_R = 1 \text{ V}, f = 1\text{MHz}$		2239		pF	Fig. 6
		$V_R = 400 \text{ V}, f = 1\text{MHz}$		192			

Thermal/Package Characteristics

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Thermal Resistance, Junction - Case	R_{thJC}			0.33		$^\circ\text{C}/\text{W}$	Fig. 9
Weight	W_T			6.0		g	
Mounting Torque	T_M	Screws to Heatsink			1.1	Nm	

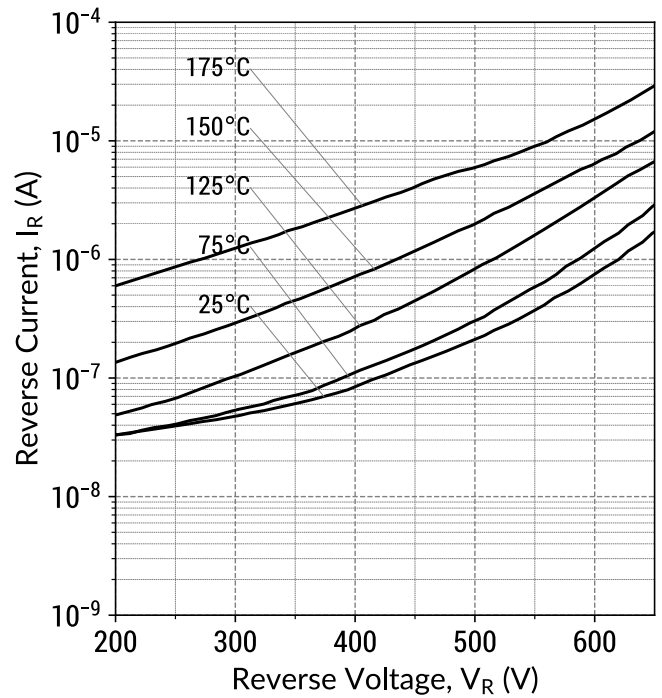


Figure 1: Typical Forward Characteristics



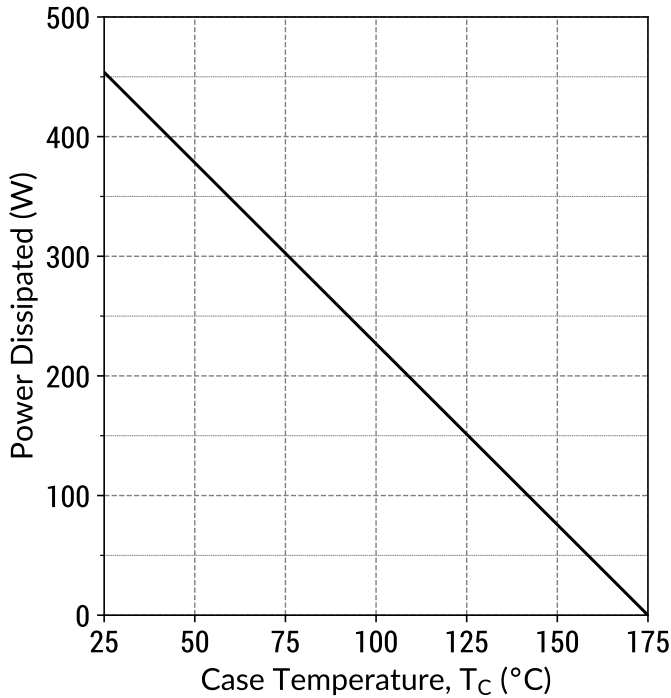
$$I_F = f(V_F, T_j); t_P = 250 \mu s$$

Figure 2: Typical Reverse Characteristics



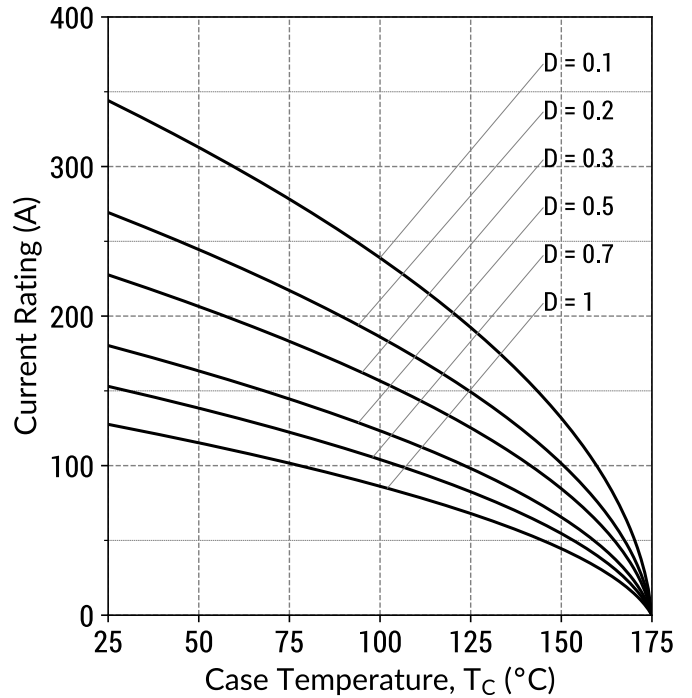
$$I_R = f(V_R, T_j)$$

Figure 3: Power Derating Curves



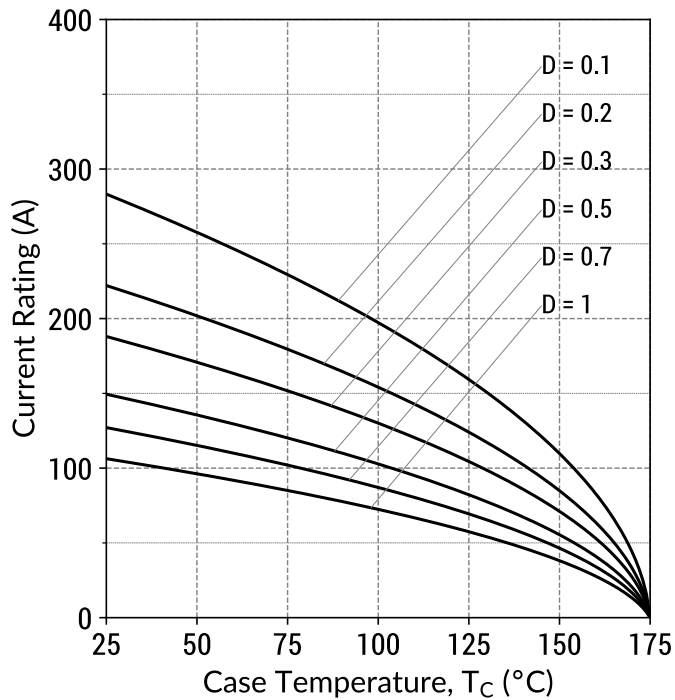
$$P_{TOT} = f(T_C); T_j = 175^\circ C$$

Figure 4: Current Derating Curves (Typical V_F)



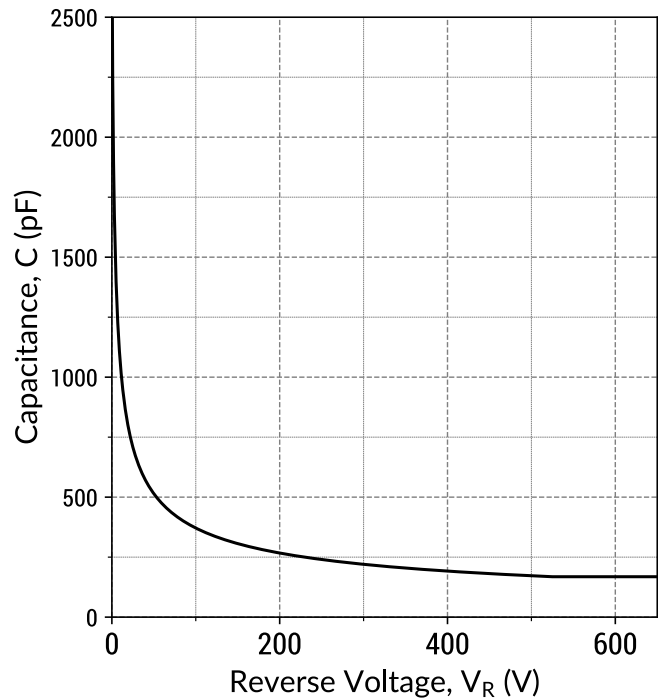
$$I_F = f(T_C); D = t_P/T; T_j \leq 175^\circ C; f_{sw} > 10 kHz$$

Figure 5: Current Derating Curves (Maximum V_F)



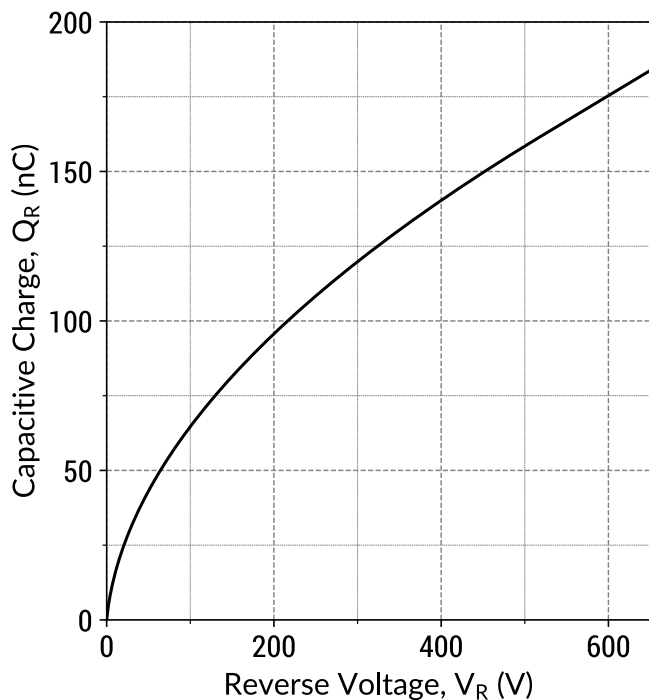
$I_F = f(T_C)$; $D = t_p/T$; $T_j \leq 175^\circ\text{C}$; $f_{sw} > 10\text{kHz}$

Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics



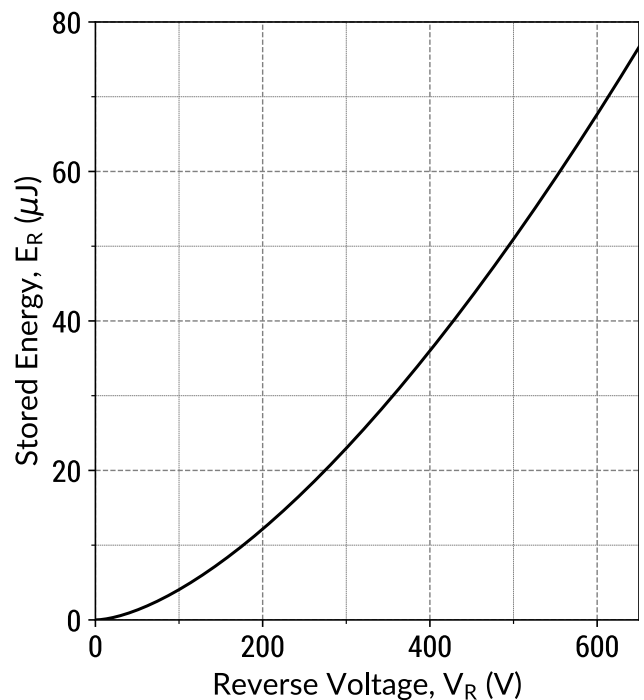
$C = f(V_R)$; $f = 1\text{MHz}$

Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics



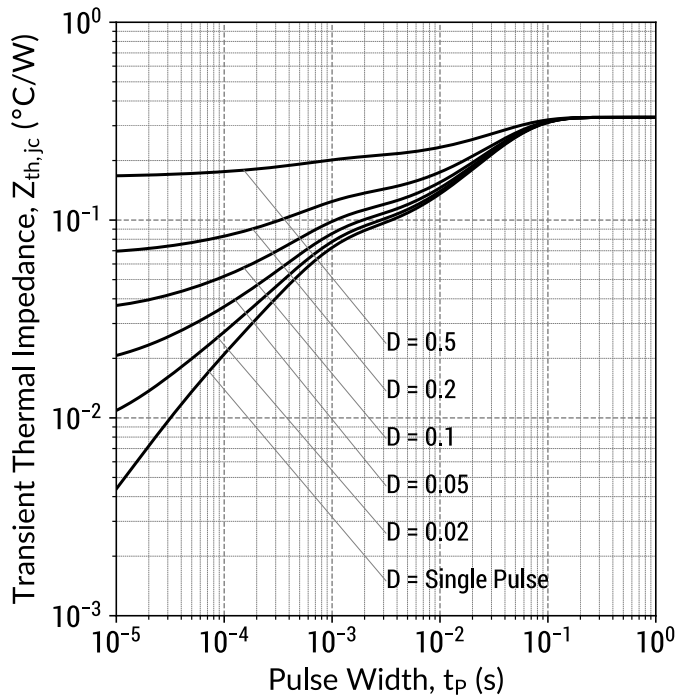
$Q_C = f(V_R)$; $f = 1\text{MHz}$

Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics



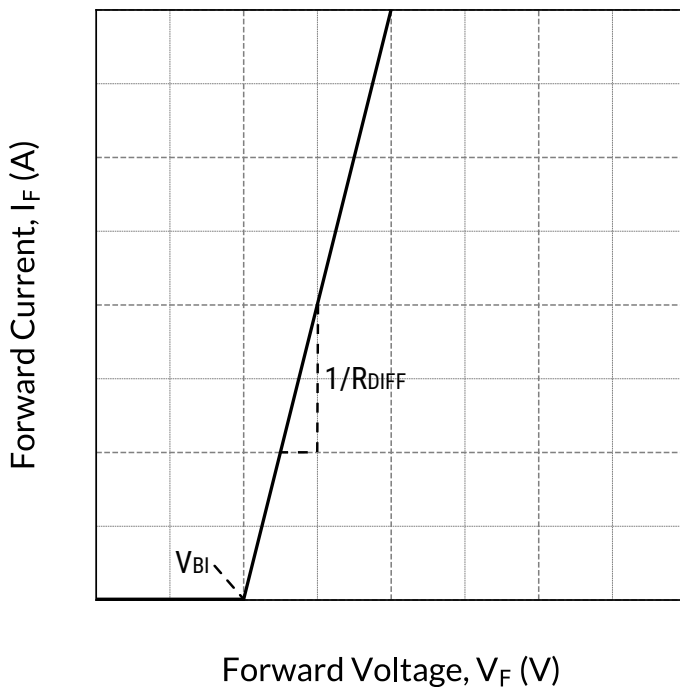
$E_C = f(V_R)$; $f = 1\text{MHz}$

Figure 9: Transient Thermal Impedance



$$Z_{th,jc} = f(t_p, D); D = t_p/T$$

Figure 10: Forward Curve Model



$$I_F = f(V_F, T_j)$$

Forward Curve Model Equation:

$$I_F = (V_F - V_{BI})/R_{DIFF} \text{ (A)}$$

Built-In Voltage (V_{BI}):

$$V_{BI}(T_j) = m \times T_j + n \text{ (V)}$$

$$m = -0.0012 \text{ (V/°C)}$$

$$n = 0.916 \text{ (V)}$$

Differential Resistance (R_{DIFF}):

$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c \text{ (}\Omega\text{)}$$

$$a = 3.16e-07 \text{ (}\Omega\text{/°C}^2\text{)}$$

$$b = 4.55e-06 \text{ (}\Omega\text{/°C)}$$

$$c = 0.0125 \text{ (}\Omega\text{)}$$

Forward Power Loss Equation:

$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

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